Ceramic

High Pass Filter

HFCG-2750+

50Ω 2900 to 16000 MHz

The Big Deal

- Small size 0.079" X 0.049" X 0.037"
- Good Power handling
- Ceramic construction

Generic photo used for illustration purposes only
CASE STYLE: GE0805C-9

Product Overview

HFCG-2750+ is a high pass filter with passband from 2900 MHz to 16000 MHz supporting a variety of applications. This model provides 1 dB typical insertion loss over a wide band due to strategically constructed layout. Housed in a tiny 0805 ceramic form factor with wraparound terminations, the filter is ideal for dense PCB layouts with minimal performance variation due to parasitics.

Key Features

Feature	Advantages
Small size, 0.079" X 0.049" X 0.037"	Accommodates tight space requirements for dense PCB layouts.
Wrap around termination	Provides excellent solderability and easy visual inspection capability.
LTCC construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes.
Ultra-wide pass band	This filter has a very wide passband from 2.9 GHz to 16 GHz.

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CASE STYLE: GE0805C-9

+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

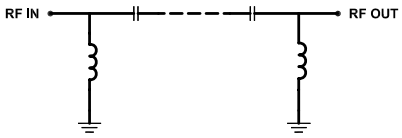
Features

- Small size
- Temperature stable
- LTCC construction
- Good power handling, 4W

Applications

- Transmitters / Receivers
- Test and measurements
- Military applications
- Telecommunications and broadband wireless systems

Functional Schematic



Electrical Specifications[1,2] at 25°C

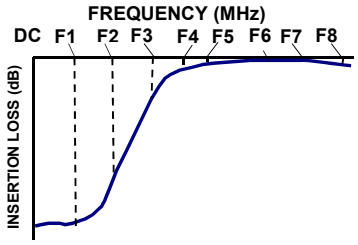
Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Stop Band	Rejection Loss	DC-F1	DC - 1000	30	36	-	dB
		F1-F2	1000 - 2000	28	34	-	dB
	Freq. Cut-Off	F3 *	2750	-	3.0	-	dB
Pass Band	Insertion Loss	F4-F5	2900 - 3100	-	2.0	-	dB
		F5-F6	3100 - 3500	-	1.4	2.1	dB
		F6-F7	3500 - 14000	-	1.0	1.6	dB
		F7-F8	14000 - 16000	-	1.0	-	dB
	Return Loss	F4-F8	2900 - 16000	-	14	-	dB

1 This component is not intended to act as a DC block. Please consult with Mini-Circuits for further details
2 Measured on Mini-Circuits Characterization Test Board TB-1125+
* Typically, a ±5% frequency deviation from the stated value may occur on a unit-to-unit basis.

Maximum Ratings	
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
RF Power Input*	4 W at 25°C

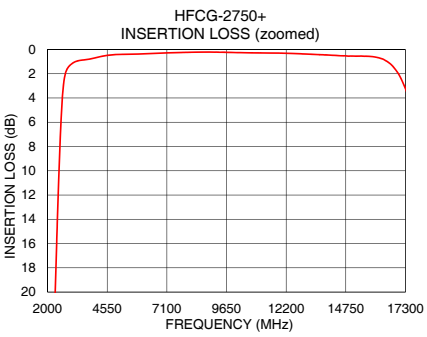
*Passband rating, derate linearly to 0.7 W at 125°C ambient
Permanent damage may occur if any of these limits are exceeded.

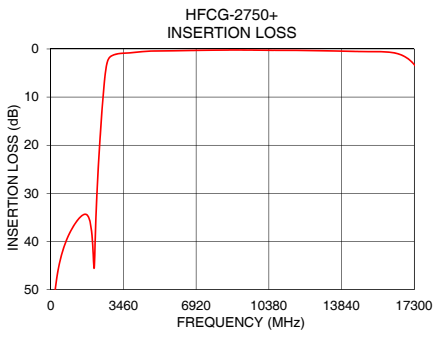
Typical Frequency Response

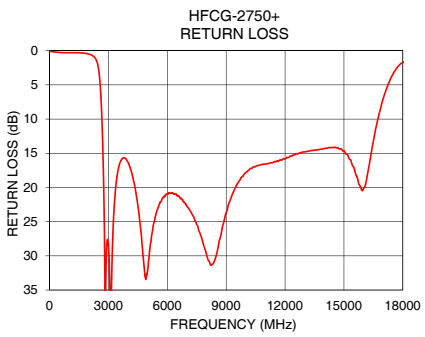


Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
10	70.91	0.11
100	56.20	0.13
500	43.01	0.26
1000	37.43	0.29
2000	40.88	0.49
2190	30.96	0.73
2320	20.54	1.08
2670	3.11	10.45
2700	2.61	13.08
2750	2.07	18.90
2900	1.42	29.13
3000	1.23	28.64
3100	1.09	38.88
3500	0.87	17.34
4000	0.71	16.34
10000	0.25	17.81
14000	0.46	14.30
16000	0.62	20.12
17500	4.36	3.43
18000	8.66	1.72







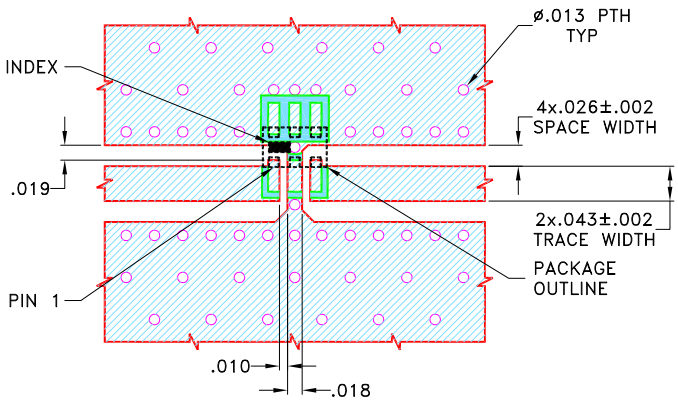
Notes
A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Pad Connections

INPUT	1
OUTPUT	3
GROUND	2, 4, 5, 6

Product Marking: MA

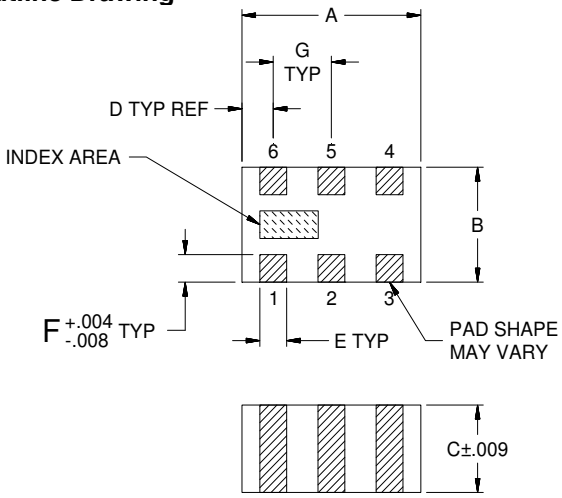
Demo Board MCL P/N: TB-1125+
Suggested PCB Layout (PL-633)



NOTES:
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B) WITH DIELECTRIC THICKNESS .020±.0015. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Outline Drawing



Outline Dimensions (inch / mm)

A	B	C	D	E	F	G	Wt.
.079	**.049**	**.037**	**.014**	**.012**	**.012**	**.026**	grams
2.00	1.25	0.95	0.35	0.30	0.30	0.65	.008

Note: Please refer to case style drawing for details

Ceramic High Pass Filter HFCG-2750+

Typical Performance Data

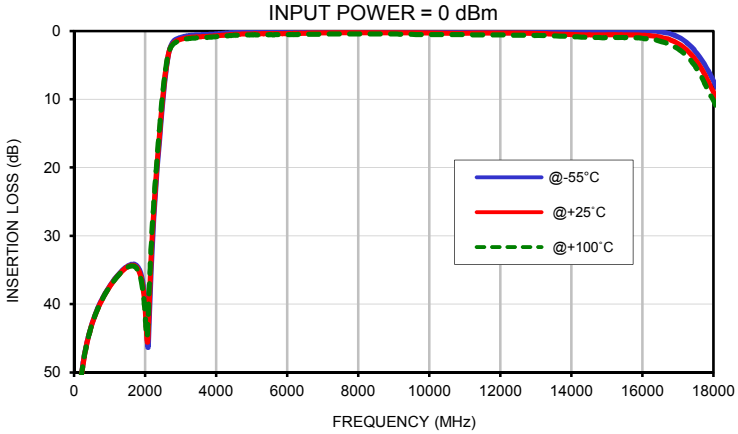
FREQ. (MHz)	INSERTION LOSS (dB)			INPUT RETURN LOSS (dB)			OUTPUT RETURN LOSS (dB)		
	@-55°C	@+25°C	@+100°C	@-55°C	@+25°C	@+100°C	@-55°C	@+25°C	@+100°C
10	67.02	78.36	69.19	0.08	0.11	0.12	0.08	0.11	0.13
20	68.82	71.30	71.79	0.08	0.11	0.12	0.08	0.11	0.13
80	58.30	58.31	58.18	0.08	0.13	0.14	0.07	0.13	0.15
100	56.52	56.15	56.45	0.08	0.13	0.15	0.08	0.14	0.16
200	50.59	50.49	50.60	0.11	0.17	0.18	0.12	0.18	0.20
300	47.16	47.22	47.24	0.14	0.20	0.22	0.15	0.22	0.25
400	44.74	44.88	44.89	0.15	0.22	0.25	0.17	0.25	0.29
500	42.93	42.99	43.01	0.17	0.26	0.29	0.18	0.28	0.32
600	41.42	41.51	41.52	0.15	0.26	0.29	0.19	0.29	0.33
700	40.19	40.29	40.28	0.17	0.28	0.31	0.19	0.30	0.35
800	39.12	39.24	39.22	0.15	0.27	0.31	0.18	0.31	0.36
900	38.19	38.29	38.28	0.15	0.28	0.32	0.18	0.31	0.37
1000	37.37	37.45	37.46	0.14	0.27	0.32	0.17	0.31	0.37
1500	34.44	34.56	34.61	0.12	0.30	0.36	0.15	0.33	0.42
1800	34.59	34.88	35.10	0.16	0.36	0.46	0.18	0.40	0.51
2000	39.64	40.72	41.64	0.26	0.49	0.61	0.28	0.52	0.65
2100	44.93	42.31	39.85	0.33	0.58	0.72	0.37	0.63	0.79
2150	37.31	35.39	33.65	0.38	0.64	0.78	0.41	0.68	0.85
2190	32.44	31.01	29.63	0.44	0.71	0.87	0.48	0.77	0.95
2200	31.40	30.05	28.73	0.46	0.73	0.89	0.49	0.78	0.96
2250	26.81	25.74	24.61	0.55	0.84	1.02	0.56	0.86	1.07
2300	22.91	21.98	20.97	0.66	0.97	1.19	0.68	1.01	1.25
2320	21.47	20.57	19.60	0.72	1.05	1.27	0.73	1.07	1.33
2400	16.12	15.33	14.46	1.06	1.47	1.77	1.06	1.49	1.85
2450	13.01	12.29	11.50	1.46	1.96	2.37	1.43	1.95	2.43
2500	10.11	9.49	8.81	2.08	2.71	3.29	2.00	2.67	3.31
2550	7.51	7.04	6.51	3.08	3.91	4.72	2.96	3.85	4.75
2600	5.30	5.02	4.70	4.71	5.83	6.95	4.55	5.73	6.95
2650	3.64	3.56	3.43	7.22	8.70	10.12	6.89	8.43	9.99
2670	3.13	3.12	3.07	8.54	10.18	11.72	8.16	9.87	11.57
2700	2.52	2.61	2.63	10.88	12.76	14.46	10.34	12.29	14.20
2750	1.86	2.06	2.16	16.17	18.52	20.44	14.89	17.29	19.55
2800	1.48	1.74	1.87	24.44	27.42	28.93	20.34	23.01	25.51
2850	1.27	1.54	1.69	42.55	35.19	33.45	24.44	26.39	28.15
2900	1.13	1.41	1.55	27.77	28.67	30.14	24.14	25.87	27.96
2950	1.03	1.30	1.45	24.66	26.69	29.21	23.49	25.60	28.13
3000	0.94	1.22	1.36	24.59	27.40	31.09	24.01	26.86	30.54
3050	0.87	1.14	1.28	25.70	29.62	34.22	25.95	30.02	35.90
3100	0.80	1.08	1.22	28.51	34.07	35.92	29.58	36.92	44.37
3150	0.75	1.02	1.17	33.69	35.30	30.45	36.97	39.78	32.68
3200	0.70	0.98	1.13	33.81	29.88	26.50	37.33	30.60	26.90
3250	0.66	0.94	1.09	29.08	25.96	23.69	29.54	26.30	24.05
3300	0.63	0.92	1.07	25.18	23.12	21.64	25.09	23.11	21.52
3350	0.61	0.89	1.04	22.73	21.19	20.11	22.86	21.42	20.30
3400	0.59	0.88	1.03	20.63	19.51	18.72	20.80	19.77	18.86
3460	0.57	0.86	1.01	18.91	18.17	17.56	18.81	18.14	17.52
3500	0.57	0.85	1.00	18.12	17.58	17.07	18.35	17.84	17.26
3520	0.56	0.85	1.00	17.79	17.35	16.90	17.96	17.55	17.04
3600	0.54	0.83	0.97	16.71	16.60	16.37	16.97	16.84	16.52
3660	0.53	0.81	0.96	15.98	16.05	15.91	16.13	16.19	15.96
3700	0.53	0.81	0.94	15.66	15.82	15.77	15.87	16.02	15.94
4000	0.43	0.70	0.83	15.61	15.99	16.44	15.69	16.10	16.56
5000	0.11	0.41	0.56	36.06	32.68	30.52	35.88	32.90	31.19
7000	0.08	0.29	0.46	25.28	25.28	24.44	25.02	25.01	24.19
10000	0.16	0.31	0.54	16.55	16.01	15.88	16.93	16.05	15.78
12000	0.24	0.30	0.59	17.72	17.06	15.84	17.67	17.50	16.54
14000	0.05	0.51	0.83	12.98	13.45	13.61	12.64	13.29	13.50
16000	0.08	0.64	1.06	19.84	21.35	18.44	25.71	36.31	24.77
17500	3.08	4.29	5.31	3.31	3.58	3.63	3.90	4.02	3.92
18000	7.29	8.95	10.17	1.07	1.56	1.73	1.36	1.98	2.25

Typical Performance Data

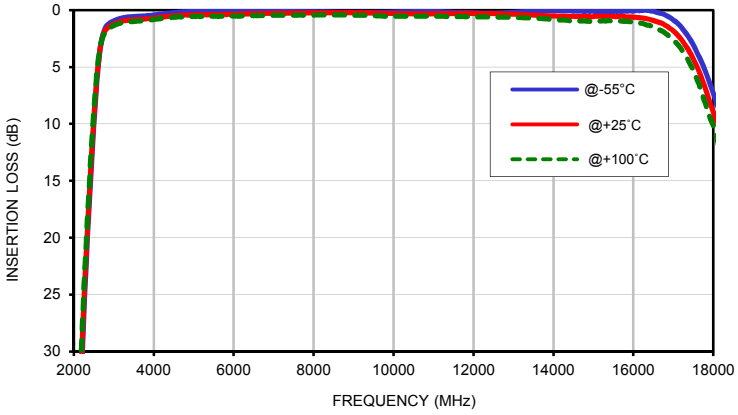
FREQ. (MHz)	GROUP DELAY (nsec)		
	@-55°C	@+25°C	@+100°C
2850	0.72	0.69	0.66
2900	0.64	0.62	0.59
3000	0.53	0.52	0.50
3200	0.41	0.40	0.39
3400	0.33	0.32	0.31
3600	0.28	0.27	0.26
3800	0.24	0.23	0.22
4000	0.21	0.20	0.20
4200	0.18	0.18	0.18
4400	0.17	0.16	0.16
4600	0.15	0.15	0.15
4800	0.14	0.14	0.13
5000	0.13	0.12	0.12
5500	0.10	0.10	0.10
6000	0.09	0.09	0.08
6500	0.08	0.08	0.07
7000	0.07	0.07	0.07
7500	0.07	0.06	0.06
8000	0.06	0.06	0.06
8500	0.06	0.06	0.05
9000	0.06	0.06	0.05
9500	0.06	0.05	0.05
10000	0.05	0.05	0.05
10200	0.05	0.05	0.05
10500	0.05	0.05	0.05
11000	0.05	0.05	0.05
11200	0.05	0.05	0.05
11500	0.05	0.05	0.05
11700	0.05	0.05	0.05
12000	0.06	0.05	0.05
12200	0.06	0.05	0.05
12500	0.06	0.05	0.05
12700	0.06	0.05	0.05
13000	0.06	0.05	0.05
13500	0.06	0.06	0.05
13800	0.06	0.06	0.05
14000	0.06	0.06	0.05
14500	0.06	0.06	0.06
16000	0.09	0.09	0.09
17500	0.13	0.13	0.12
18000	0.09	0.09	0.08

Typical Performance Curves

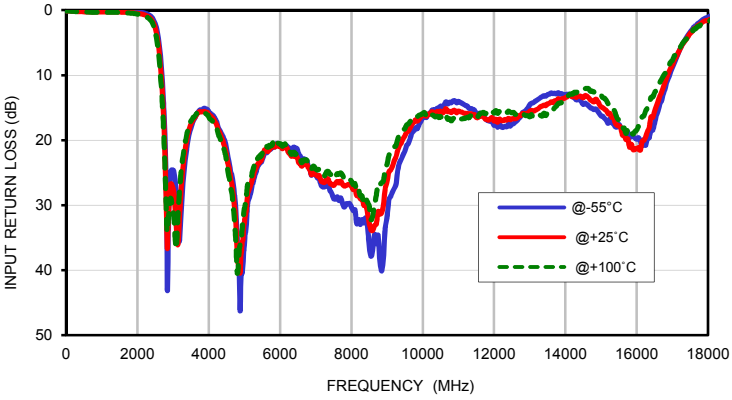
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



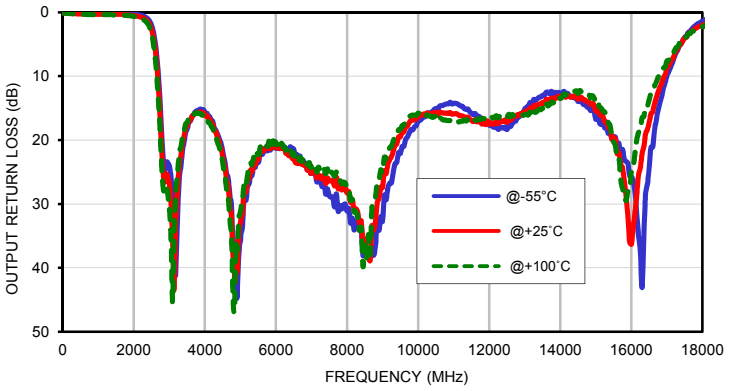
INSERTION LOSS vs. TEMPERATURE (Zoomed)
INPUT POWER = 0 dBm



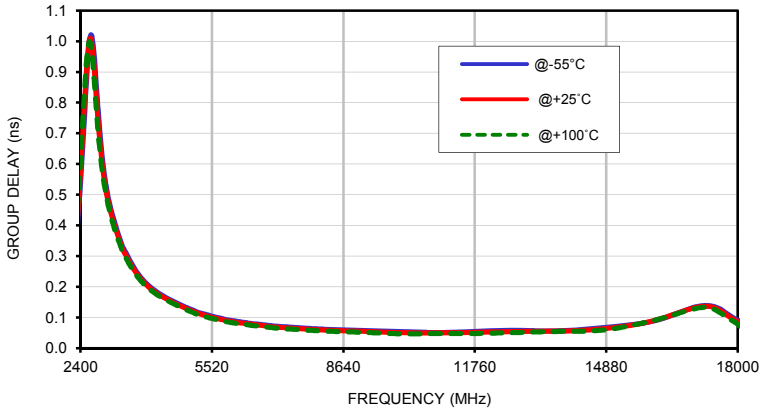
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm

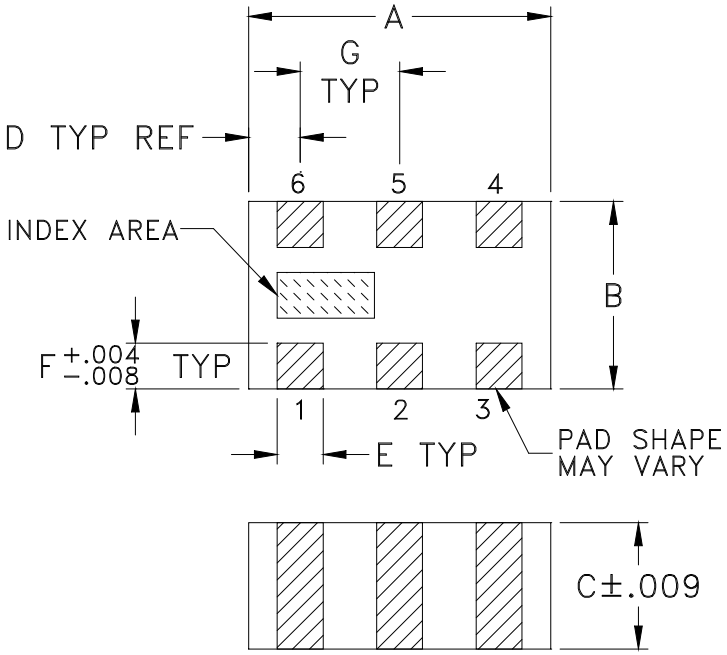


GROUP DELAY vs. TEMPERATURE
INPUT POWER = 0 dBm

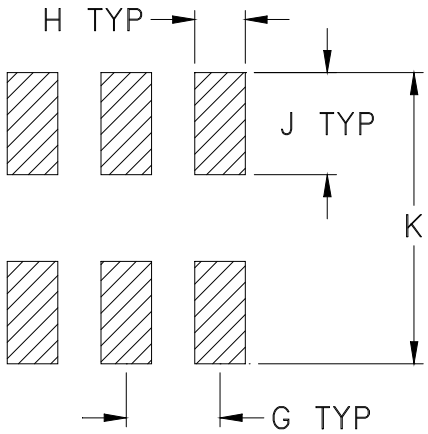


GE0805C-9

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	WT.GRAM
GE0805C-9	.079 (2.00)	.049 (1.25)	.037 (0.95)	.014 (0.35)	.012 (0.30)	.012 (0.30)	.026 (0.65)	.014 (0.35)	.039 (1.00)	.110 (2.80)	.008

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, ceramic base.
2. Termination finish: For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Styles: Tin-Lead plate over Nickel plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F114

DEVICE ORIENTATION IN T&R

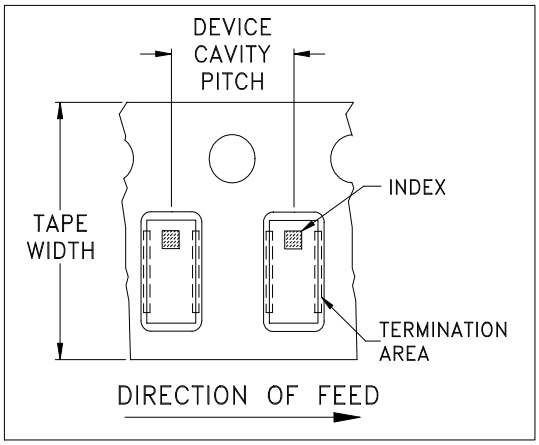


ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	

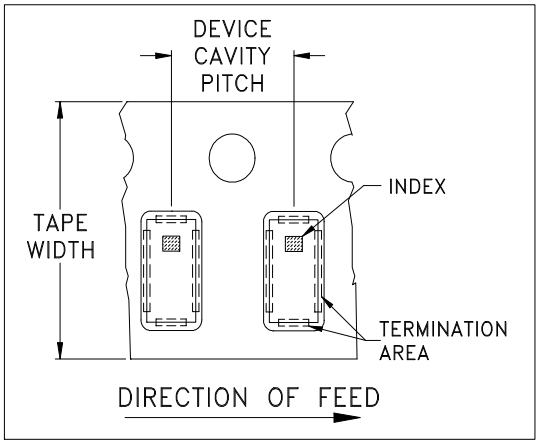


ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	JV1210C-1
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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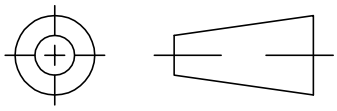
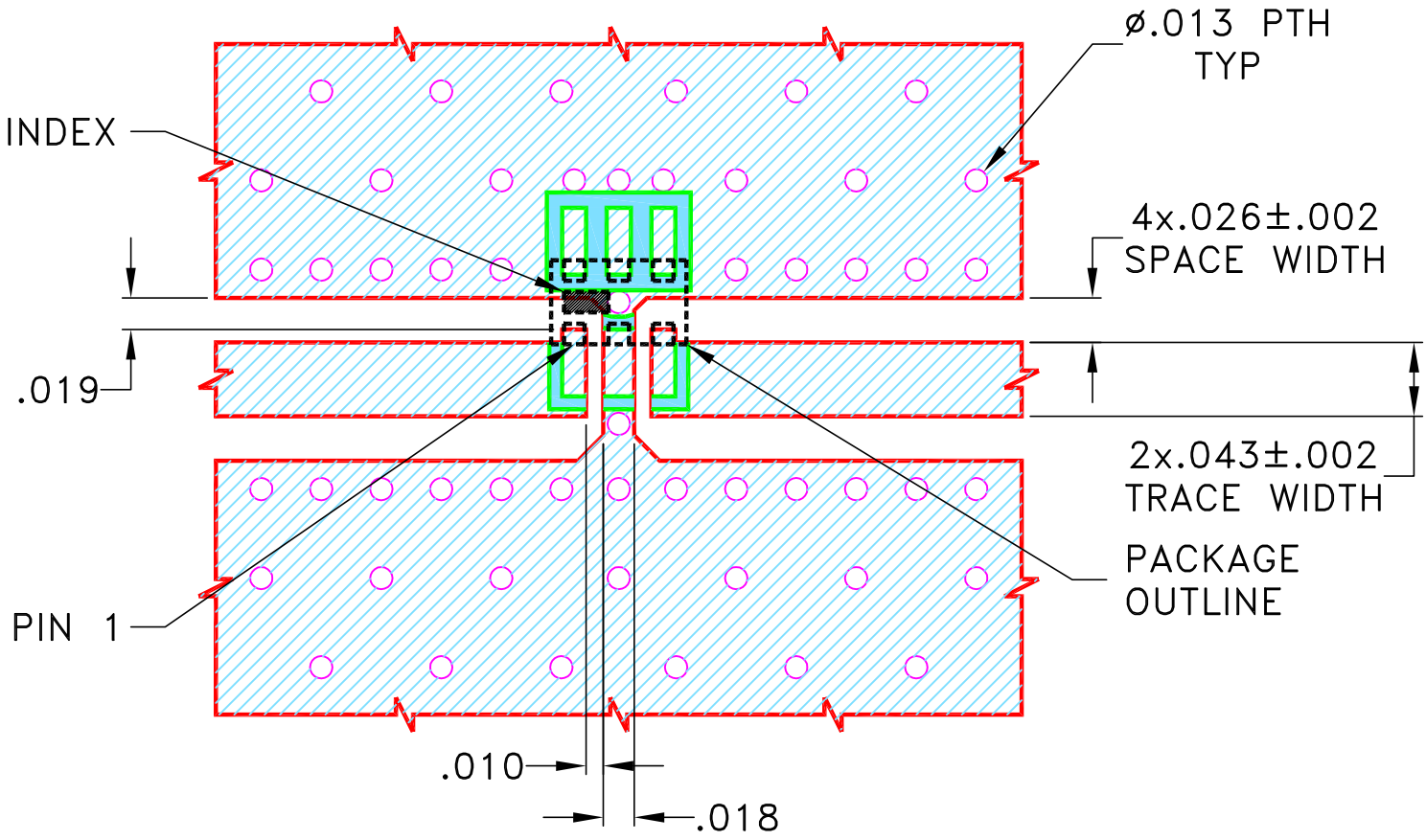
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-001011	NEW RELEASE	DEC 19	DDR	VC

SUGGESTED MOUNTING CONFIGURATION FOR GE0805C-9 CASE STYLE



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1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B) WITH DIELECTRIC THICKNESS .020±.0015. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	DDR	16 DEC 19
TOLERANCES ON:	CHECKED	RV	16 DEC 19
2 PL DECIMALS ±	APPROVED	RKS	16 DEC 19
3 PL DECIMALS ± .005"			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits®
13 Neptune Avenue
Brooklyn NY 11235

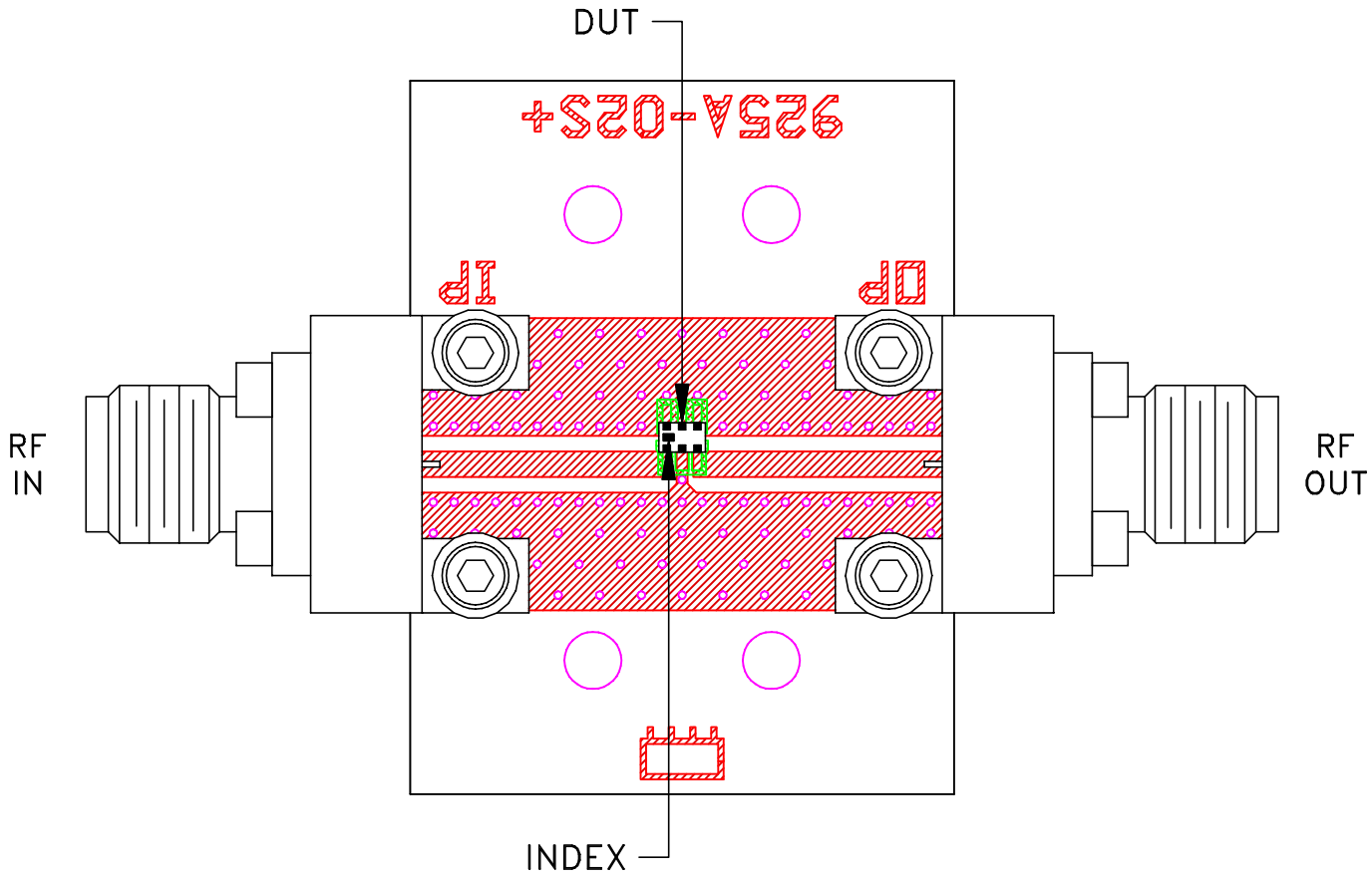
PL, GE0805C-9, TB-1125+

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-662	OR

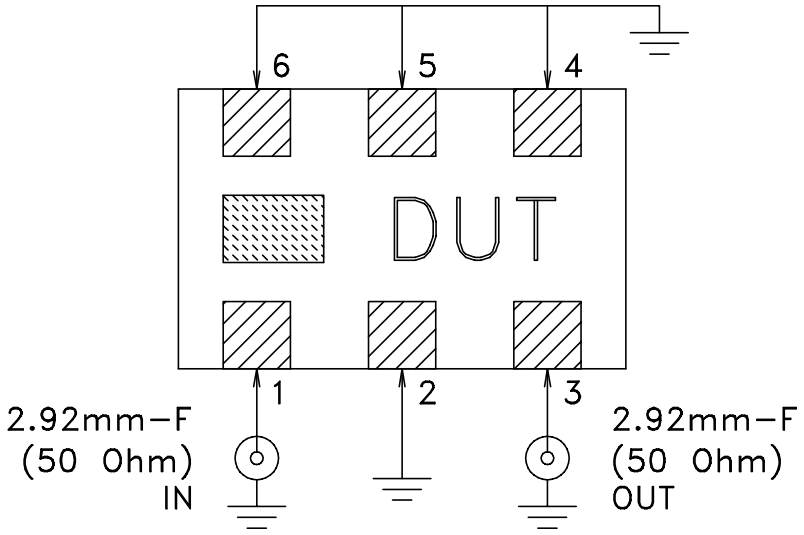
FILE:	SCALE:	SHEET:
98PL662	9:1	1 OF 1

Evaluation Board and Circuit

TB-1125+



Schematic diagram



Notes:

1. PCB Material: ROGERS (RO4350B) OR Equivalent, Dielectric Constant=3.48±.05
Dielectric Thickness: .020
2. 50 Ohm 2.92mm Female Connectors.

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Environmental Specifications ENV126

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A